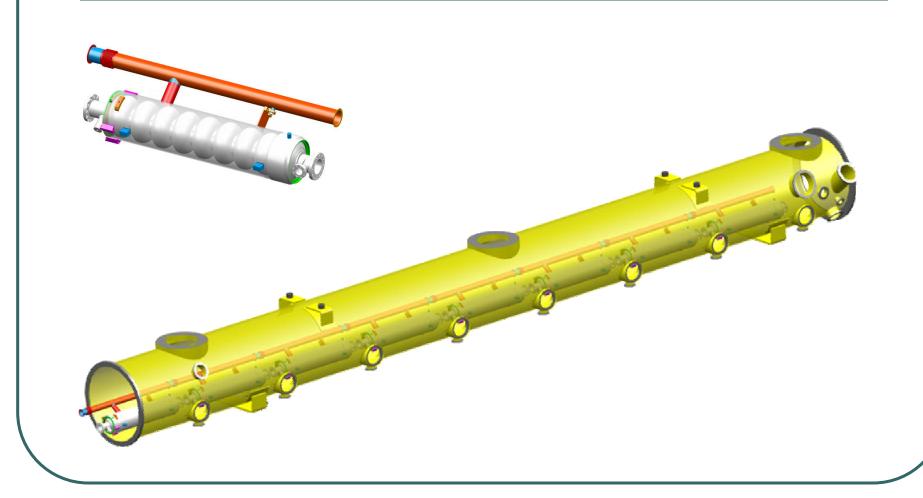
ILC Cryomodule Fabrication Strategy



ILC Cryomodule Fabrication Strategy

OUTLINE

- Goals
- Plans to Accomplish Goals
- Current Status of Work
- Overall Fabrication Strategy
- Conclusion

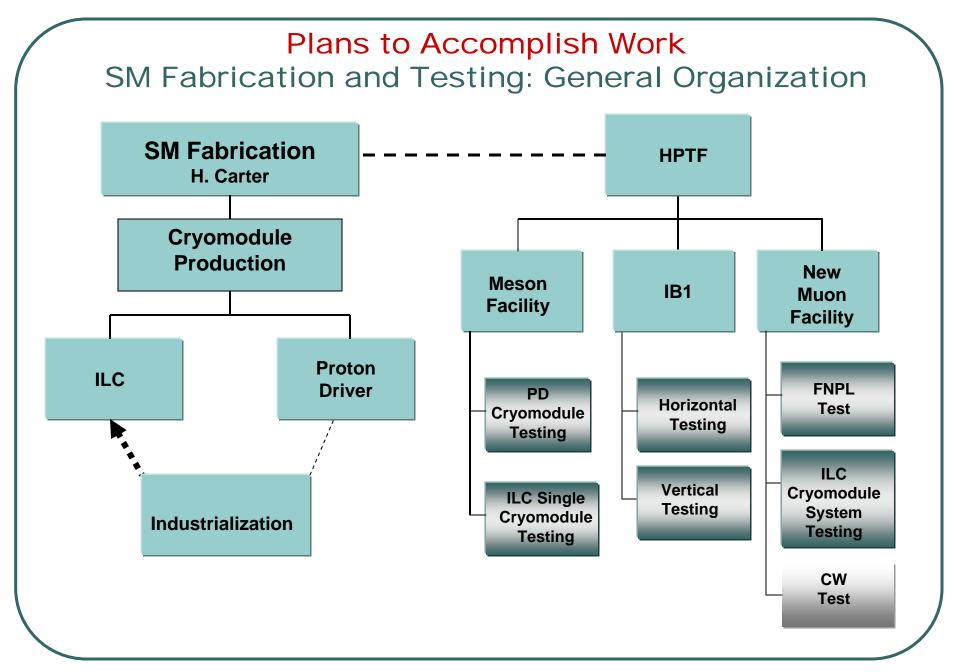
ILC Cryomodule Fabrication Strategy

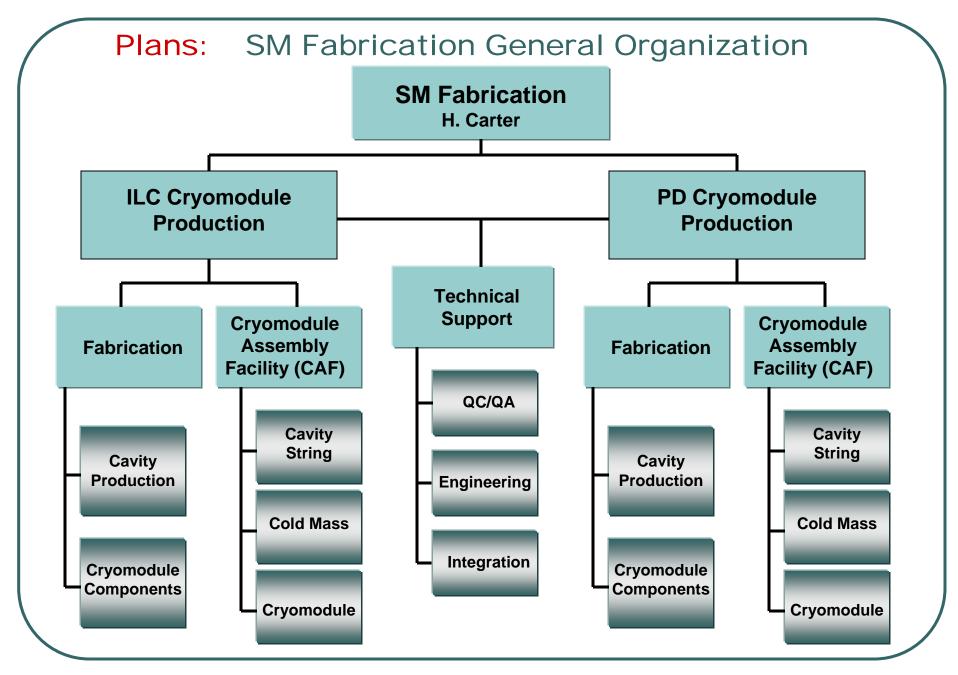
Goals

- Goals are established and prioritized by FNAL SRFSC
- The primary goal is to fabricate sufficient ILC cryomodules within a given period to populate the SMTF
- Another important goal is the establishment of a substantial R&D effort in cavity fabrication and processing which results a repeatable method of producing cavities which meet the desired accelerating gradient of > 35MV/m
- FY05 goals shown on next slide

FY05 Goals Established by the FNAL SRFSC (in support of ILC & SMTF)

- Design & build Horizontal Test Cryostat (or Chechia vessel)
- Create infrastructure to support 1st U.S. built cryomodule construction in CY 06
- Complete joint FNAL/ANL BCP facility
- Begin 1.3 GHz cavity industrialization efforts
- 3.9 GHz Cavities
 - Complete six accelerating cavities (FNAL/JLab effort)
 - Continue deflecting cavity R&D
 - Complete single cavity A0 cryostat(s)
- Complete Capture Cavity #2





Fabrication: Cavity Production Organization Chart



FNAL Facility

M. Foley Team Leader

S. Reeves Production Documentation Engr,

Fixturing & Tooling

Al Butler Fixturing & Tooling Design

B. Smith Technical Support

D. Snee Technical Support

Collaboration Efforts

M. Foley, Coordinator H. Padamsee, Cornell

W. Funk, JLab

J. Cornuelle, SLAC

Industrialization

M. Foley Coordinator Accel, M. Peininger AES, T. Favale

Cavity Processing Organization Chart

Cavity Processing

ANL/FNAL Facility

A. Rowe Responsible Engineer

C. Boffo Process Controls Support,

Facility Design & Commissioning

I. Terechkine Facility Design & Commissioning

T. Arkan Clean Room Design Support

& Process Fixturing Development

W. Muranyi Lead Technician for Operations

M. Battistoni Operations Support Technician

D. Assell Installation Support Technician

D. Connolly Installation Support Technician

B. Smith Installation Support Specialist

A0 Facility

A. Rowe, Responsible Engineer

W. Muranyi, Lead Technician

Collaboration Facilities

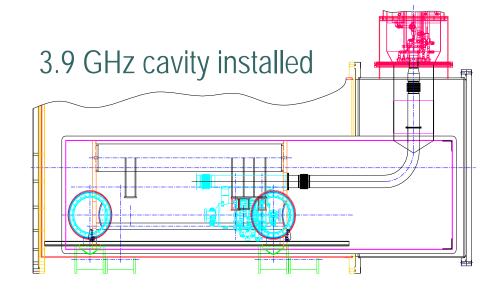
A. Rowe, Coordinator

Industrial Facilities

A. Rowe, Coordinator

Horizontal Test Cryostat (Chechia)

- •Required for high power testing of single, dressed cavities
- •Our design will accommodate both 3.9GHz and 1.3GHz cavity testing

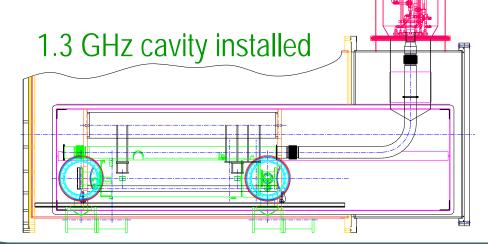




Horizontal Test Cryostat, cont.

1.3 GHZ Cavity

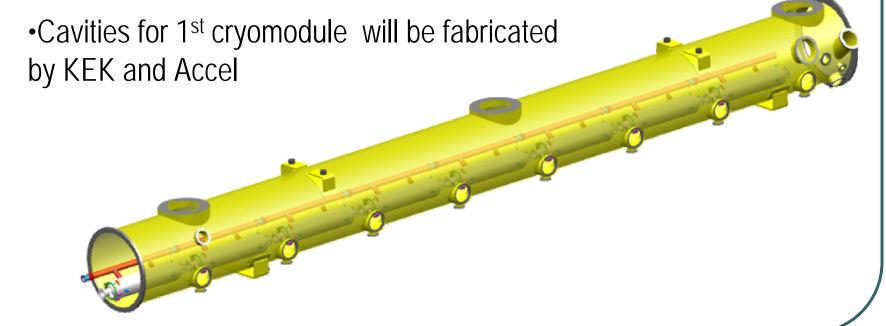
- Design work will be completed in FY05
- •Major components will be ordered early in FY06
- •Planned to be operational in Spring 2006





Support Infrastructure for 1st U.S. Built Cryomodule

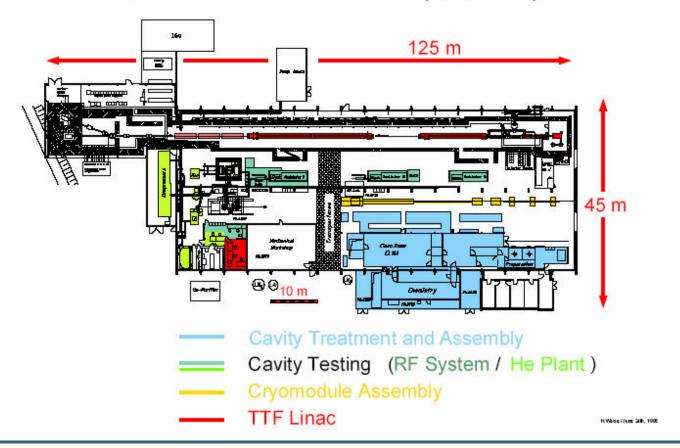
- A 3-D model of the TTF 1.3 GHZ Cryo3 Vessel has been created.
- Preparation of "Americanized" drawings is in progress (consistent with a CY06 deliverable).



Support Infrastructure for 1st U.S. Built Cryomodule: MP9 Cryomodule Assembly Facility Development

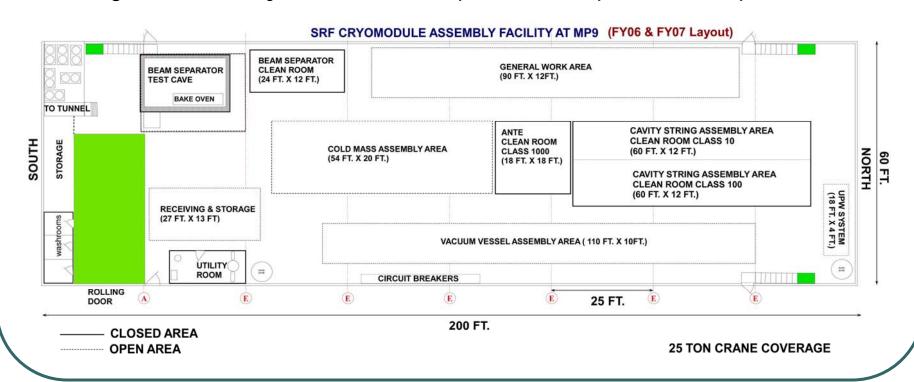
•A facility layout based on DESY's Hall 3 facility (below) is planned

TESLA TEST FACILITY (HALL 3)



Support Infrastructure for 1st U.S. Built Cryomodule: MP9 Cryomodule Assembly Facility (CAF) Development

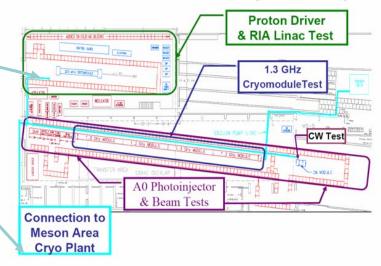
- Tevatron Separator Work at MP9 ends this Fall (~Nov. 2005)
- •Building is sufficiently sized for R&D production quantities (1 per month)



MP9 Cryomodule Assembly Facility Development



FNAL Meson Area SM&TF Layout Concept







Joint FNAL/ANL BCP Facility

- •Design, construction, and test operation (using water) of FNAL system completed. System now disassembled and ready to be transported to ANL for installation in the newly constructed room inside Building 150.
- •FNAL safety review of system completed. A complete ANL safety review will be conducted once the system is installed there.

•Design and construction of 3.9 GHz etching jackets almost complete.

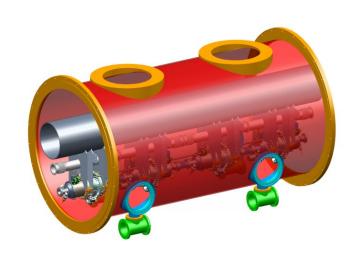
1.3GHz etching jacket design will commence once the 3.9GHz work is complete.

- Infrastructure tooling and fixturing development to support 3.9GHz and 1.3GHz cavity etching underway.
- Facility is scheduled for completion and initial operations by end of CY05

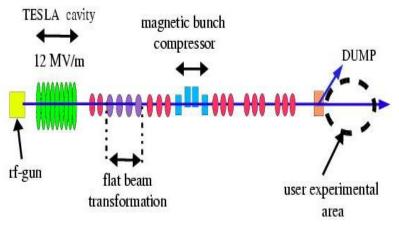
3.9 GHz Cavities & Cryostat(s): Work in Progress

- Design coldmass supports, both sliding and fixed
- Design coldmass and cryostat
- Main coupler design
- Helium vessel design complete but may need minor revision
- Helium supply pipe redesign (spacing & material)
- Heat Loads and cool-down analysis





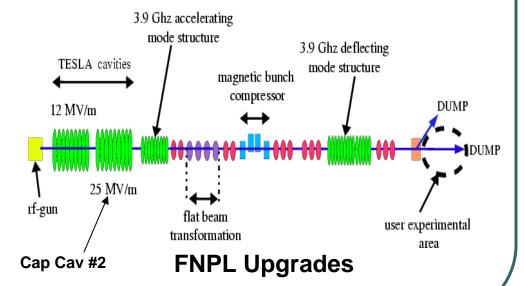
Capture Cavity #2





Existing FNPL

Required for A0
 Photoinjector upgrade



Capture Cavity #2 Status

- Cryostat with poor performing 1.3GHz 9-cell cavity was received from DESY and has been disassembled
- •DESY to supply a higher gradient replacement cavity and peripheral components which will be installed when they are received
- Engineering design work well underway
- •Scheduled for installation and commissioning at Meson Lab by Sept.-Oct. 2005, and then will undergo a testing program there

Overall Fabrication Strategy

- Infrastructure Development:
 - Utilize as much existing engineering designs for fixturing, tooling, processes and procedures to establish facilities at Fermilab as quickly as possible
 - Utilize existing facilities at
- Cavity Development:
 - Utilize available resources for cavities for first cryomodule (KEK, ACCEL, AES, DESY, et. al.)
 - Work with laboratories and universities (JLab, SLAC, Cornell, ANL, DESY, etc.) to develop cavity fabrication and processing capability and to develop processes and new techniques
- •Coupler Development:
 - Utilize available resources for couplers for first cryomodules (CPI)
 - Develop new, simpler designs with cost reduction and manufacturability as prime goals

Overall Fabrication Strategy (Cont.)

•Cryomodule Development:

- The first U.S. built cryomodule will be of the TESLA Type III design
- The DESY supplied cryomodule "kit" will be of the TESLA Type III design
- Type IV (ILC Prototype?) cryomodule development will proceed while the first two cryomodules are being assembled

•Industrialization:

- Identify potential suppliers of cryomodule components and initiate discussions with them
- Conduct informational meetings or workshops with industry
- Establish R&D efforts with interested, "qualified" candidates (\$\$\$\$\$)
- Work with known component vendors to improve manufacturability and reduce costs

Conclusions

- •We are making very good progress on our FY05 goals
- •Infrastructure development to support 1.3GHz cryomodule fabrication is well underway.
- •"Deliverables" to the ILC GDE:
 - Development of cavities that repeatably achieve 35MV/m accelerating gradient
 - First U. S. cryomodule will be utilized for development of assembly techniques and infrastructure
 - Development of the next generation (Type IV) ILC Cryomodule
- •A strategic approach for cryomodule production and testing that makes use of existing capabilities within the national laboratories and universities has been presented
- •Industrialization is only beginning at this time. Initial efforts are with cavity manufacturing companies, both in the United States and in Europe.